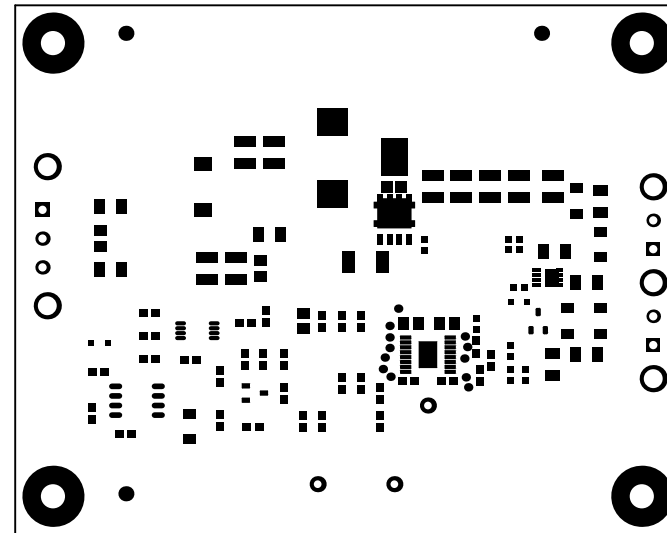
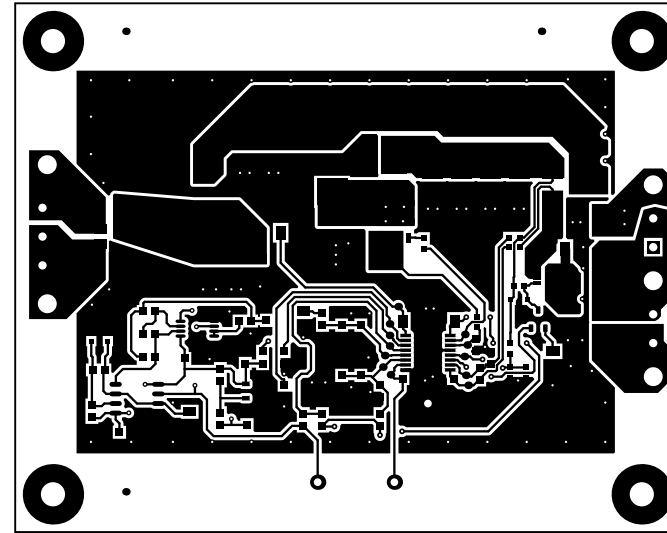


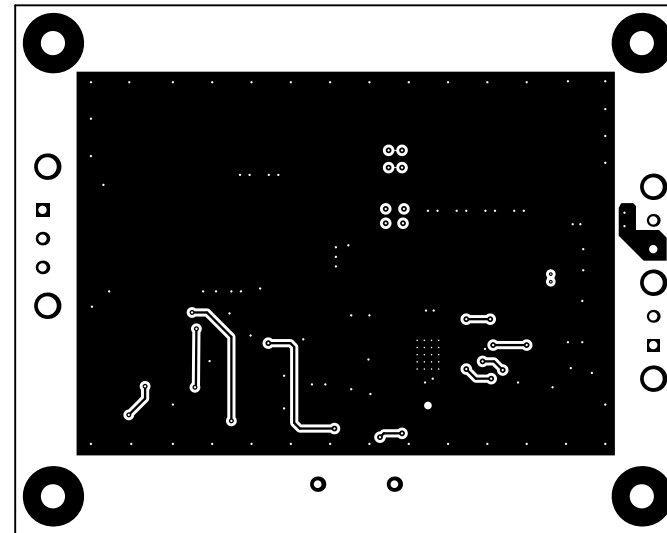
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 11/14/2016 4:46:45 PM	TEXAS INSTRUMENTS	



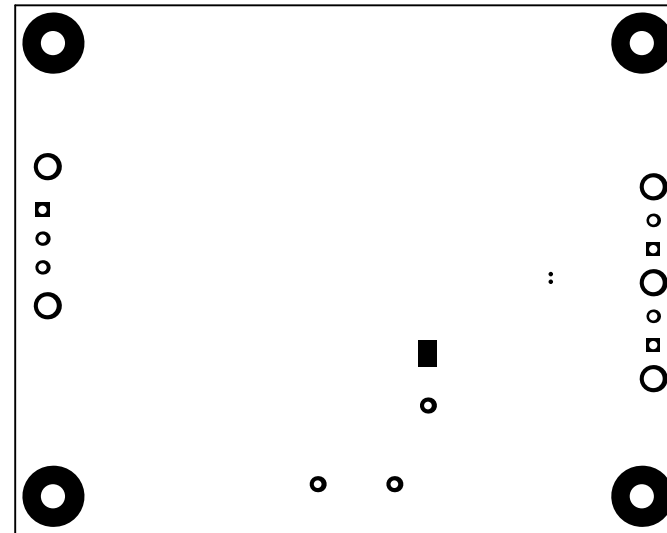
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 11/14/2016 4:46:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 11/14/2016 4:46:47 PM	TEXAS INSTRUMENTS	



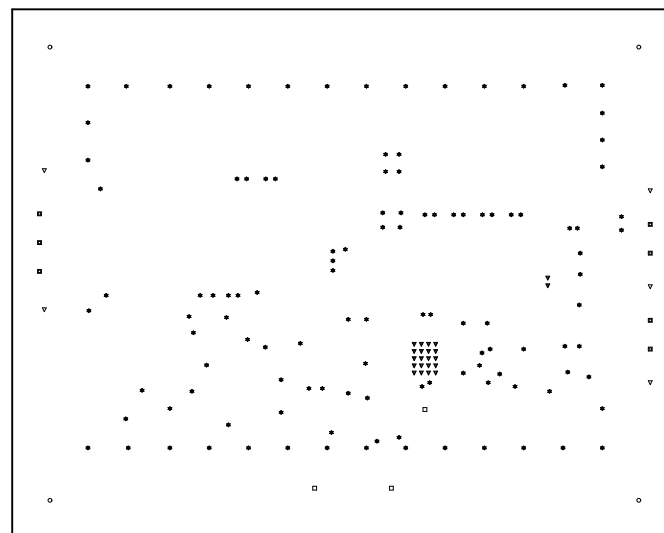
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 11/14/2016 4:46:48 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/14/2016 4:46:49 PM	TEXAS INSTRUMENTS	

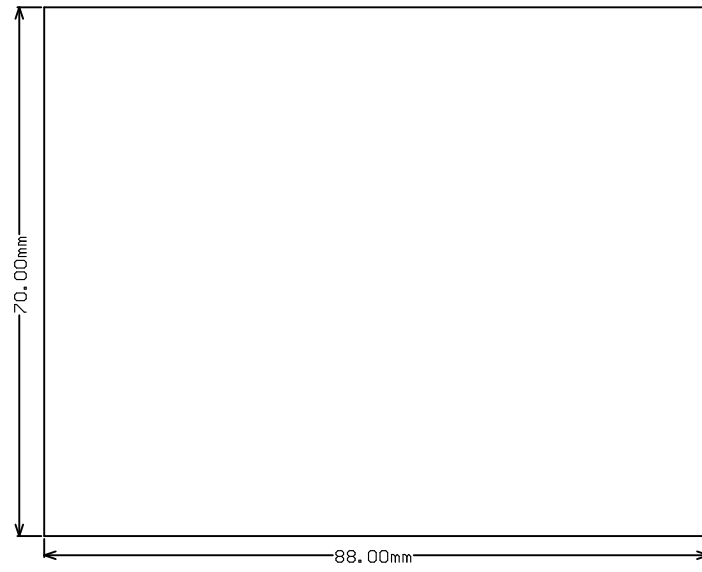


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 11/14/2016 4:46:50 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
▽	22	0.200mm (7.87mil)	PTH	Round	Top Layer - Bottom Layer	
✱	116	0.305mm (12.00mil)	PTH	Round	Top Layer - Bottom Layer	
□	3	1.016mm (40.00mil)	PTH	Round	Top Layer - Bottom Layer	
■	7	1.100mm (43.31mil)	PTH	Round	Top Layer - Bottom Layer	
▽	5	2.500mm (98.43mil)	PTH	Round	Top Layer - Bottom Layer	
○	4	3.200mm (125.98mil)	PTH	Round	Top Layer - Bottom Layer	
	157 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME =	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 11/14/2016 4:46:52 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01183	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 11/14/2016 4:46:53 PM	TEXAS INSTRUMENTS	



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